ALUMINUM ELECTROLYTIC CAPACITORS

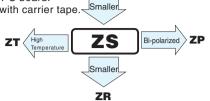
4.5mmL Chip Type series



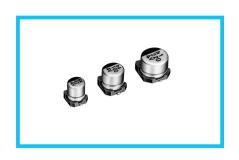
For SMD Smaller An

- Chip type with 4.5mm height.
- Designed for surface mounting on high density PC board.
- Applicable to automatic mounting machine fed with carrier tape.

• Compliant to the RoHS directive (2011/65/EU).



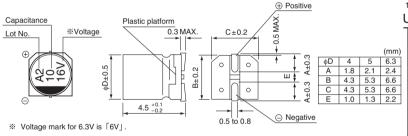
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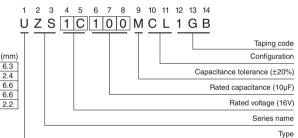
■Specifications

Item	Performance Characteristics													
Category Temperature Range	-40 to + 85°C													
Rated Voltage Range	4 to 50V													
Rated Capacitance Range	0.1 to 220μF													
Capacitance Tolerance	+20% at 120Hz, 20°C													
Leakage Current	After 2 minutes' application of rated voltage, leakage current is not more than 0.01 CV or 3 (µA) ,whichever is greater.													
											ency : 120Hz at 20°C			
Tangent of loss angle (tan δ)	Rated voltage (V)		4		6.3	1	-	16	25		35	50	-	
	tan δ (MAX.)		0.50	0	.30	0.:	24	0.19	0.16	6 0).14	0.14]	
	Measurement frequency : 120Hz													
Otability at Law Tanananatura	Rated vo		4	6.3	3	10	16	2	25	35	50			
Stability at Low Temperature	Impedance ratio Z-25°C / Z-			7	4		3	2		2	2	2		
	ZT / Z20 (MAX.)	Z-40°C / Z-	+20°C	15	8		8	4		4	3	3		
	The specifications listed at right shall be met when the capacitors are restored to 20°C after the rated tan δ							citance change Within			in ±20% of the initial capacitance value			
Endurance								3 200%			6 or less than the initial specified value			
	voltage is applied for 2000 hours at 85°C. Leakage current Less than or equal to the initial specified value										ue			
Shelf Life	After storing the capacitors under no load at 85°C for 1000 hours and then performing voltage treatment based on JIS C 5101-4 clause 4.1 at 20°C, they shall meet the specified values for the endurance characteristics listed above.													
	The capacitors are kept on a hot plate for 30 seconds, which is maintained at 250°C. The capacitors shall meet the characteristic requirements listed at right when they are removed from the plate and restored to 20°C.							Capacitance change Within			Within :	in ±10% of the initial capacitance value		
Resistance to soldering								tan δ				an or equal to the initial specified value		
heat								Leakage	Leakage current Less than			n or equal to the initial specified value		
Marking	Black print on the case top.													

■Chip Type



Type numbering system (Example : $16V 10\mu F$)



Dimensions

	V		4	6	.3	1	0	1	16	2	25	3	35	5	0
Cap. (µF)	Code	0	iG	0J		1A		1C		1E		1V		1H	
0.1	0R1		!		!		!		!					4	1.0
0.22	R22		İ						İ					4	2.0
0.33	R33		İ		İ		İ		İ		1			4	2.8
0.47	R47		I I		1		!		!		!		!	4	4.0
1	010				İ				İ					4	8.4
2.2	2R2		1		I I		I I		İ		1		İ	4	13
3.3	3R3		 		!		!		!		!			4	17
4.7	4R7		İ		İ		 		İ	4	16	4	18	5	20
10	100		İ		l I		I I	4	23	5	27	5	29	6.3	33
22	220		I I	4	28	5	33	5	37	6.3	42	6.3	46		
33	330	4	28	5	37	5	41	6.3	49	6.3	52				1
47	470	4	33	5	45	6.3	52	6.3	58				İ		I I
100	101	5	56	6.3	70										1
220	221	6.3	96		i		i		i		i			Case size φD (mm)	Rated ripple

Rated ripple current (mArms) at 85°C 120Hz

• Frequency coefficient of rated ripple current

o requestoy occurrent or ration reprise current											
Frequency	50 Hz	120 Hz	300 Hz	1 kHz	10 kHz or more						
Coefficient	0.70	1.00	1.17	1.36	1.50						

- Taping specifications are given in page 23.
- Recommended land size, soldering by reflow are given in page 18, 19.
- Please select UR(p.150), UG(p.158) series if high C/V products are reqired.
- Please refer to page 3 for the minimum order quantity.

CAT.8100D